

Features

- Low voltage operation
- Low current consumption
- Miniature SMD package size
- I²C communication protocol
- Reliable capacitive technology
- Relative humidity accuracy of ±2 % (Typical)



BPS230 Series - 2 mm Humidity Sensor

Absolute Maximum Ratings Supply Voltage (V _{CC})	-0.3 to 7.0 \
nput Voltage (V _I)	0.0 to 7.0
CE	-0.3 to V ₂₂ + 0.3 \
SCL/SDA	
Output Voltage (VO)	
fi-level Output Current (IOH)	
1 Terminal	-5 m/
All Terminals Total	
ow-level Output Current (IOL)	
1 Terminal	5 m/
All Terminals Total	
Operating Temperature (T _a)	
Storage Temperature (T _{stg})	
Recommended Operating Conditions	
Power Supply Voltage (V _{cc})	1.62 to 5.5 VD0
Capacitance between V _{CC} and V _{SS} (C _D)	0.1 μF typica
Pull Up Resistor Value on SDA1 (R1)	5 kΩ typica
Pull Up Resistor Value on SCL1 (R2)	5 kΩ typica
Select the resistance value to meet AC characteristics.	
Electrical Characteristics	
lumidity Detection	
Measurement Range	0 to 100 % RI
Resolution (10-bit).	0.1 % RH typica
Humidity Accuracy - Typical (see Humidity Sensor Accuracy Graph for Maximum Rating)	
@ 25 °C (20 to 80 % RH)	±2 % Rŀ
@ 5 °C to 45 °C (0 to 100 % RH)	±4 % RI
Hysteresis @ 5 °C to 45 °C (0 to 100 % RH)	±1 % RH typica
Response Time	
Reach (τ 63 % @ 25 °C, wind velocity @ 1.0 m/s)	8 seconds
Inless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -20 °C to 100 °C	
emperature Detection	
Measurement Range	30 °C to +100 °C (-22 °F to +212 °F
Resolution (11 bit)	
-10 °C to +70 °C	
All other temperatures	0.4 °C (0.72 °F
Temperature Accuracy	
@ 5 °C to 60 °C	
@ -20 °C to 85 °C	
Reproducibility @ -30 °C to 100 °C	± 0.1 °C (±0.18 °F
Response Time Reach (τ 63 % (dependent on surrounding heat conduction NOTE 1)	
Inless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -30 °C to 100 °C	
IOTE 1 Extended exposure to >90 % RH causes a shift of up to 3 % RH which is reversible after	r a period of 14 days.
Current Consumption	
Sleep Current (CE=0, Sleep Mode)	10 nA typical, 400 nA maximur
Noorage Operating Current	



Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = 0 °C to 60 °C

Applications

Industrial:

- HVAC systems
- Process monitoring
- Packaging automation

- **Medical Devices (low/medium risk):
- Diagnostic equipment
- Analysis equipment

BPS230 Series - 2 mm Humidity Sensor

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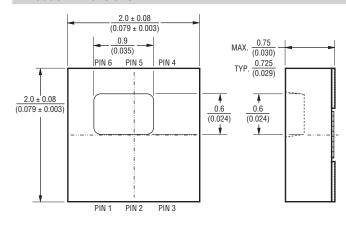
Input/Output Terminal Characteristics

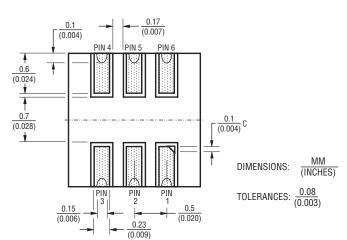
Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -30 °C to 100 °C

Product Characteristics

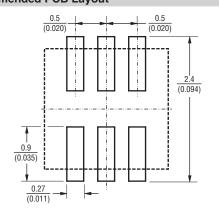
Moisture Sensitivity Level	1
ESD Classification (HBM)	1 kV
Marking	■. Date Code
Standard Packaging	
Weight	0.050 (0.000)

Product Dimensions





Recommended PCB Layout



Terminal Assignment

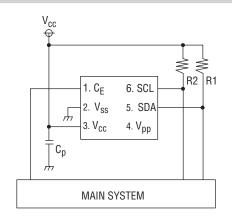
No.	Terminal Name	Function
1	CE	Chip enable terminal
2	V_{SS}	Power supply terminal (-)
3	V _{cc}	Power supply terminal (+)
4	NC	No connection
5	SDA	I ² C serial data
6	SCL	I ² C serial clock

Users should verify actual device performance in their specific applications.

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Specifications are subject to change without notice.

Basic Circuit Schematic



C_p 0.1 μF 5k Ω R2 $5k \Omega$

NOTE: R1 and R2 are reference values. Resistor values should be selected to meet the AC characteristics.

Operation Mode

Operation	Terminal Setup	Operation State of Each Functional Block						
Mode	CE	V _{pp}	Power Supply	Oscillation	Temp. Detection	Capacitance Detection	OTP Memory	I ² C-Bus
Sleep *1	0	NC	Stop	Stop	Stop	Stop	Stop	Stop
Standby	1	NC	Operation	Operation	Stop	Stop	Read-out Possible	Operation

^{*1} In case of power control mode, there is no sleep operation. I²C slave address (SADR) is defined as "111 1111" (7Fh).

Control Register Map

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.		
	D7-1	-	Reserved	=			R	0		
00h	00h D0 RESET Reset	0	Normal Operation	None	R/W	0				
				1	-	Reset Action				
	D7-6	MANMODE	Manual Detection Mode	00	Normal Operation Mode					
	D5-3 HAVE[2:0]		Humidity		Humidity	000	No Averagi	ng Process	R/W	0
		HAV/FI2:01	Detection	001	2 Times Av	erage Mode				
01h	D5-3		Value Avg.	01x	4 Times Av	erage Mode				
			Mode	1xx	8 Times Av	erage Mode				
	D2		Temperature	0	8 Times Av	erage Mode				
		TAVE	Detection Value Avg. Mode	1	16 Times Av	verage Mode	R/W	0		

Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
	D1	-	Reserved	-			R	0
01h D0	MAN	Manual Detection	0	Standby State	Detection Operation Stop	- R/W	0	
	D0	IVIAN	Mode Mode	1	Under Detection Operation	Detection Operation Start	III/VV	U
	D7-1	-	Reserved	-			R	0
03h	Do	EDD	Manual	0	No Error	Nothing is Done	DAM	0
	D0	ERR	Detection Error Flag	1	Error Occurred	Error Flag Reset	R/W	0
04h	D7-0	HC[7:0]	Humidity Detection Result (After Correction Operation)		000h-3FFh		R	Х
	D7-2	-	Reserved	-			R	0
05h	D1-0	HC[9:8]	Humidity Detection Result (After Correction Operation)				R	х
06h	D7-0	TC[7:0]	Temperature Detection Result (After Correction Operation)		000h-7FFh		R	Х
	D7-3	-	Reserved	-			R	0
07h	D2-0	TC[10:8]	Temperature Detection Result (After Correction Operation)				R	Х
0Ah	D7-0	K[7:0]	Capacity Detection Result (Before Correction Operation)		000h-FFFFh		R	0

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Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
0Bh	D7-0	K[15:8]	Capacity Detection Result (Before Correction Operation)				R	0
	D7-5	-	Reserved	-	-	-	R	0
			Standard	0	Outside Capacity Cutting Outside Capacity Connection			
2Ch	D4 SCR_ON_R	Capacity Connection Control	1	R/W			0	
	D3-0	SCI_ ON_R[3:0]	Internal Capacity Connection Control	0h~Fh x 0.6 pF Example: At the time of 8 hours, access to internal capacity of 4.8 pF		R/W	Х	
	D7-1	-	Reserved	-	-		R	0
03h D0	Manual	0	No Error	Nothing is Done	5			
	D0	D0 ERR Detection Error Flag		1	1 Error Error F Occurred Rese		R/W	0

Transfer Function Formula

Humidity

RH =
$$\frac{100}{2^{10}}$$
 x RH_{IC} (0 ~ 100 % RH)

RH_{IC}: IC Humidity Output Data (10 bit)

Refer to Register Map:

 RH_{IC} = Data of the addresses 04H and 05H (000h ~ 3FFh) It changes into a decimal and is operation.

Temperature

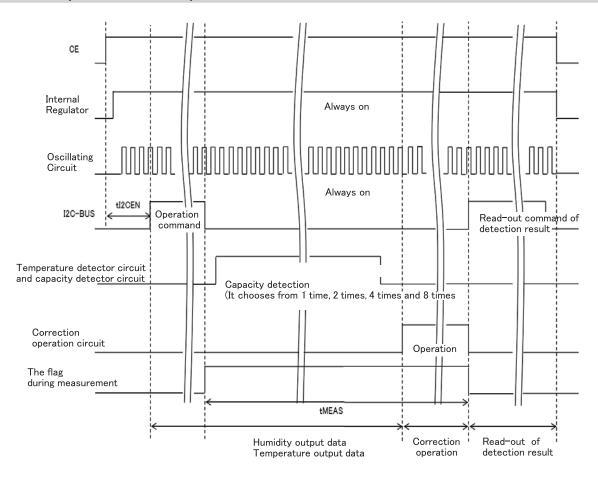
T =
$$[T_{IC} - (2^{10} - \frac{25}{0.1})] \times 0.1$$
 (-30 ~ 100 °C)

T_{IC}: IC Temperature Output Data (11 bit)

Refer to Register Map:

 T_{IC} = Data of the addresses 06H and 07H (000h ~ 7FFh) It changes into a decimal and is operation.

Capacitance/Temperature Detection Sequence

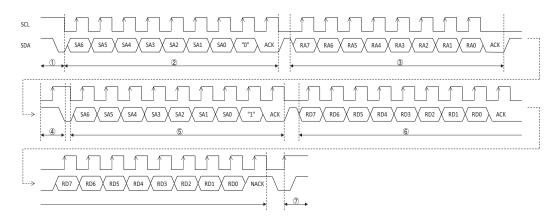


How To Order BPS230 - D 3P0 - S 10 E Model Series Humidity-Temperature Sensor Output Type D = Digital Accuracy (% RH) 3P0 = ±3.0 Moisture Sensitivity S = Standard Resolution 10 = 10-bit Packaging Designator E = 3000 pcs. per 7-inch Reel

Output Type Waveform and Data Read/Write Procedure

I²C-BUS Data Read-out Procedure

- (1) I²C master device releases START condition.
- ig(2ig) I2C master device transmits slave address and WRITE mode selection.
- (3) I²C master device transmits register address of this IC.
- (4) I²C master device releases repeated START condition. (Release method is same as START condition.)
- (5) I²C master device again transmits slave address and READ mode selection. (Read mode can be selected by transmitting "1" in 8th bit.)
- 6 I2C master device reads-out data from register address designated at 3.
 It is possible to read-out data while register address increments one, by reading-out multiple data continuously. However, during continuous read-out, please return ACK to this IC as a reply of master.
- 7) After the completion of all read-out, I²C master device releases STOP condition.



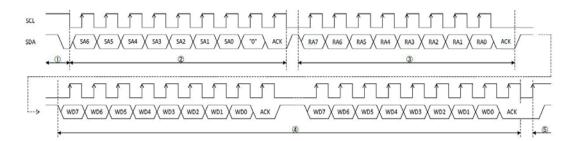
~ Continued ~

Output Type Waveform and Data Read/Write Procedure (Continued)

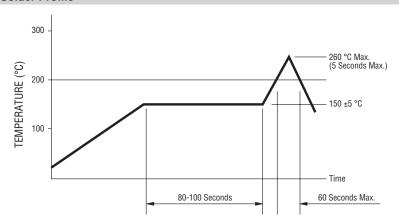
I2C-BUS Data Write-in Procedure

- (1) I²C master device releases START condition. (Start condition can be released by changing SDA from "H" to "L" while SCL is in "H" state.)
- (2) I²C master device transmits slave address and WRITE mode selection. (Write mode can be selected by transmitting "0" in 8th bit while 1~7th bits are slave address.)
- (3) I²C master device transmits register address of this IC.
- (4) I²C master device transmits write-in data.
- (5) It is possible to write-in data while register address increments one, by transmitting multiple write-in data continuously.

After the completion of transmitting all write-in data, I²C master device releases stop condition. (Stop condition can be released by changing SDA from "L" to "H" while SCL is in "H" state.)



Solder Profile



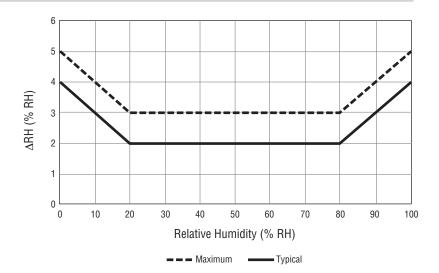
Processing Method: Reflow soldering with infrared heat or forced air convection (only once).

Notes:

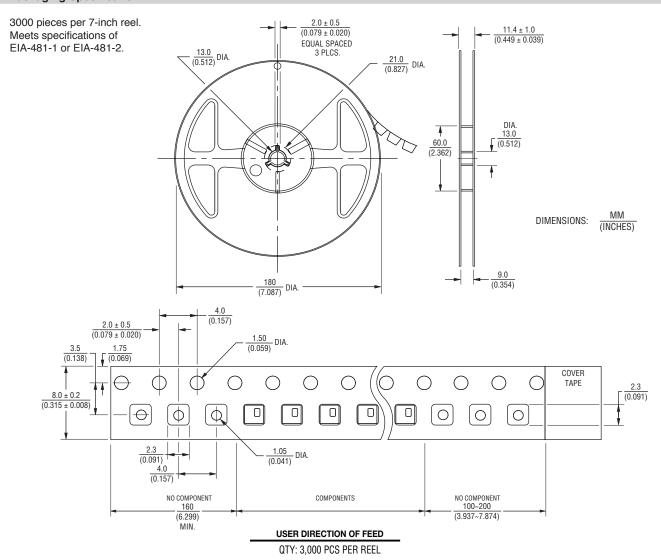
- 1. No clean solder paste is recommended.
- 2. Aqueous wash is not recommended.
- Use of water soluble soldering flux should be avoided due to possible corrosion.
- 4. Multiple passes through the soldering process is not recommended.
- Other SMD processes and profiles should be verified by the customer.

Humidity Sensor Accuracy

Relative Humidity (% RH)	Maximum	Typical
0	5	4
10	4	3
20	3	2
30	3	2
40	3	2
50	3	2
60	3	2
70	3	2
80	3	2
90	4	3
100	5	4



Packaging Specification



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